

# COM-QM77

## Thermal Image Analysis Report

Summary	<input type="checkbox"/> Pass			
	<input type="checkbox"/> Fail			
	<input checked="" type="checkbox"/> Pass with Deviation			
	<b>Comment: <u>There are three temperature points marginal passed, the function is normal, hope to get improvement for the generation.</u></b>			
Test Result Summary				
	Critical	Major	Minor	Enhancement
Defect Found	0	0	0	1
Defect Unsolved	0	0	0	1

Issue date

2012 / 08/14

Approval

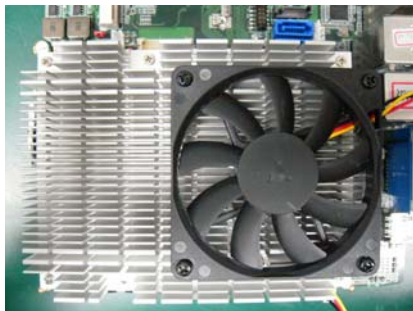
Tom Lin

Test Engineer

Matthew Chi

## Sample Configuration & Quantity Under Test

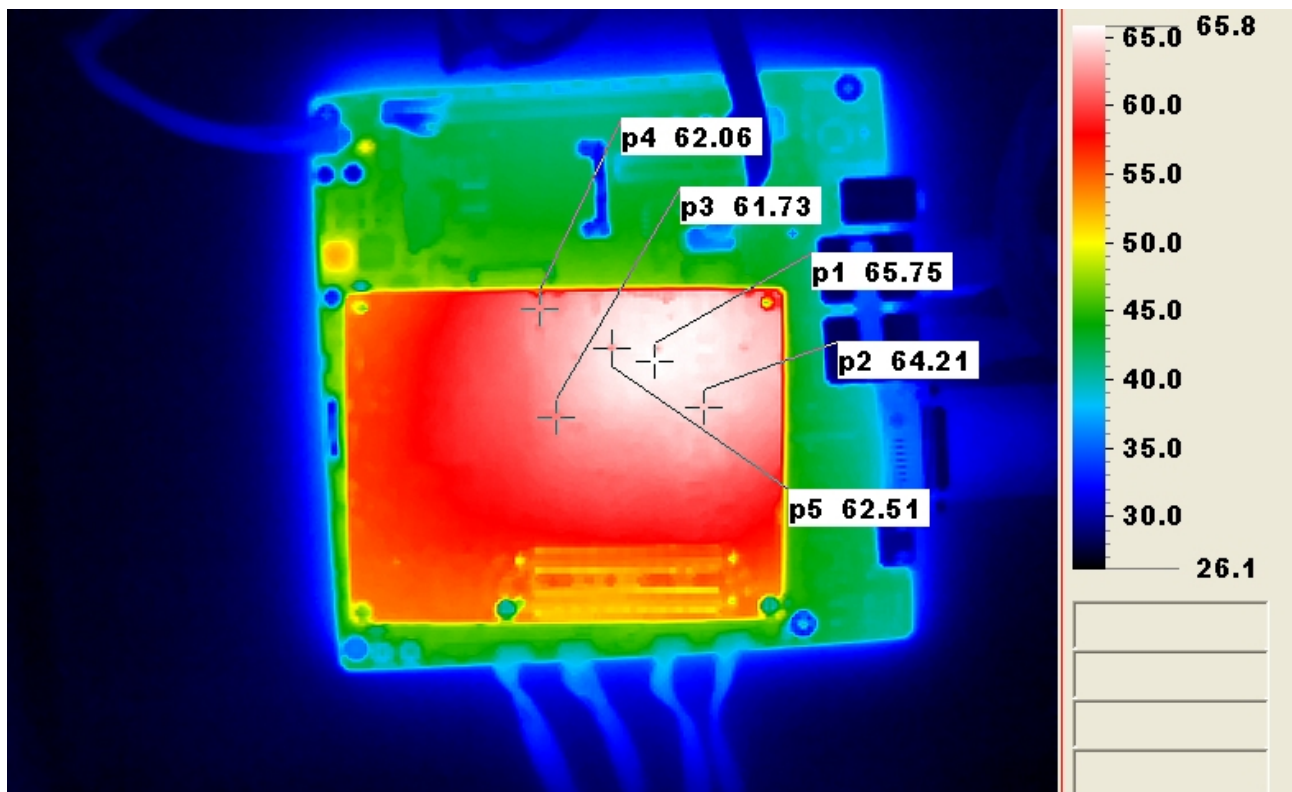
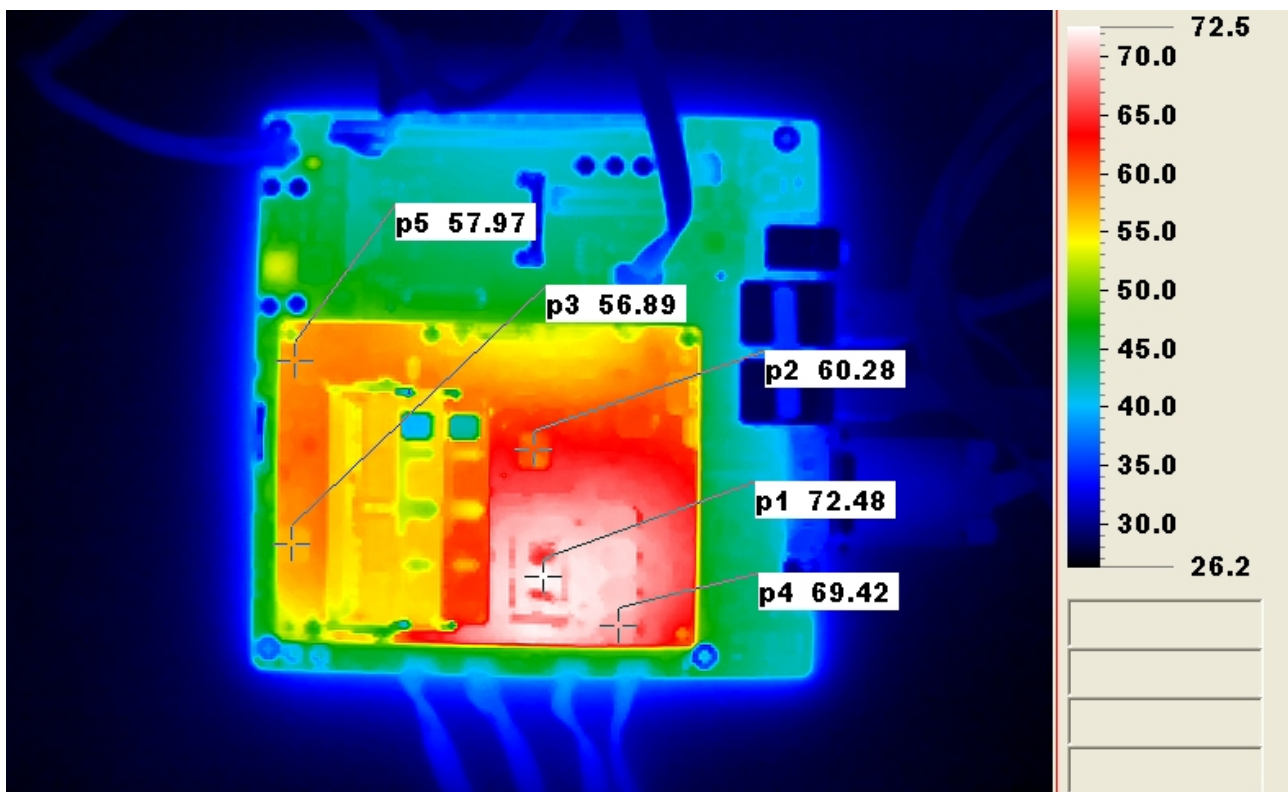
- **Model name : COM-QM77 B1.0**
- **Carrier Board : ECB-917T A1.0**
- **CPU : Intel i7 3555LE 2.50GHz**
- **Memory : Transcend DDR3-1333 4GB (SEC K4B2G0846C) x2**
- **HDD : Seagate 2.5" SATA ST9160412AS 160GB**
- **BIOS :COM-QM77 M1.4(CM77BM14)(07/25/2012)**
- **Test Software : Windows 7 / Run PassMark Burn In Test 7.0 Pro**
- **Power : AT Power Supply: CWT DSA400P-C**
- **Heat Sink:**

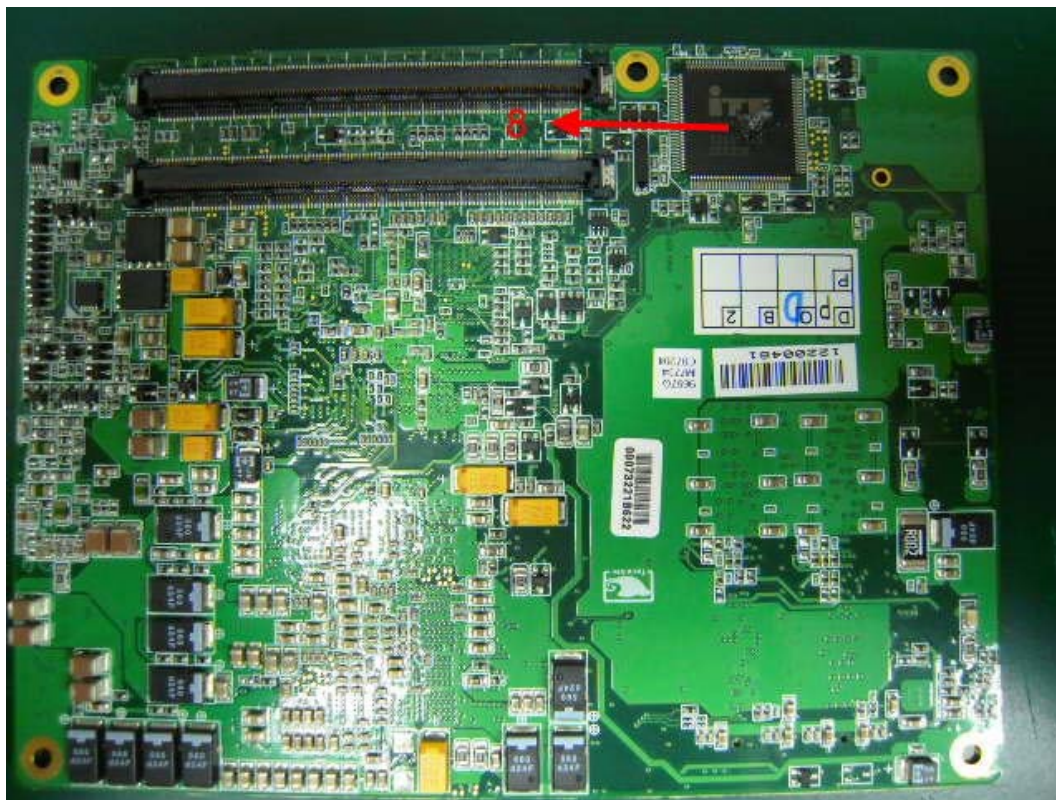
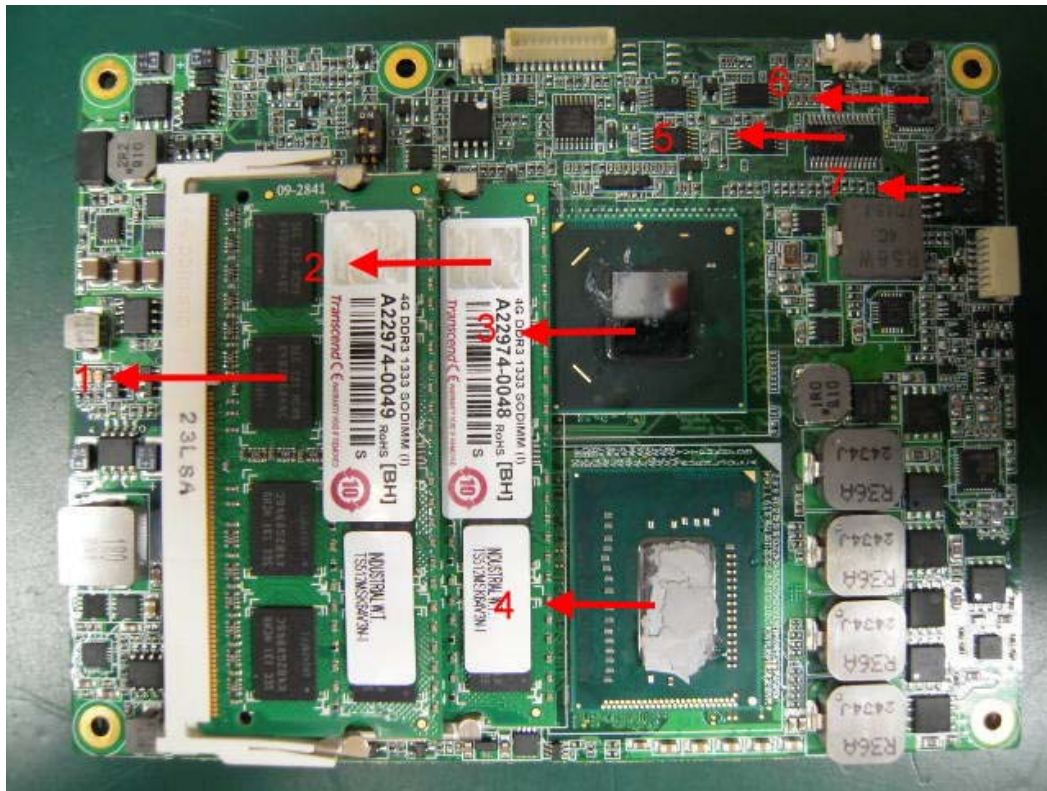


# Thermal Image Analysis

1. Test Date: 2012-08-13
2. Test Product : COM-QM77 B1.0
3. Test Site: AAEON QE Dept.
4. Temperature Measurement:
  1. OMRON ZR-RX25
  2. IR Scanner: Infrared Camera  
NIPPON AVIONICS CO., LTD.  
Model: NEC-G100D  
Date of Calibration: 2012/01/03  
Serial Number: 1051444
5. Test Condition:  
Component Side-1 (Test by ZR-RX25 ): 25°C With cooler
6. Take Picture Time:  
After power on 2 hours

### Temperature Profile Test:





**Using OMRON ZR-RX25 test**

Point	Position	Describe	Tc (*1) (°C)	Tm (*2) Measured Under		Note
				25°C	60°C	
1	Memory1	Transcend DDR3-1333 4GB (SEC K4B2G0846C)	85	47.7	82.7	
2	Memory2	Transcend DDR3-1333 4GB (SEC K4B2G0846C)	85	51.3	86.3	
3	U1	Intel Core i7 3555LE 2.50GHz	105	45.1	80.1	
4	U10	(TF)IC.SMD.Chipset PCH.INTEL.BD82QM77	108	44.4	79.4	
5	U31	(TF)IC.SMD.Trusted Platform Module.SLB9635TT1.2(F/W 3.16)	85	40.4	75.4	
6	U23	(TF)IC.PCI-E GigaBit Ethernet Chipset.Intel.WG82579LM SLHA6	106	36.4	71.4	
7	U26	(TF)IC.SMD.128M BIT SPI FLASH.MXIC.MX25L12845EMI-10G	100	37.4	72.4	
8	U32	(TF)IC.SMD.LQFP.128P.Embedded Controller.ITE.IT8518E-L	140	43.1	78.1	

**Note(\*):**

1. "Tc" indicates the component's case maximum temperature value specified in its datasheet.
2. "Tm" indicates the measured Tc value under working environmental temperature within product specification.

**3. Judgment Criteria:**

- **Fail** :  $T_m > T_c + 5^{\circ}\text{C}$ ; The measured value is over specification plus margin.
- **Margin** :  $T_c + 5^{\circ}\text{C} > T_m > T_c - 10^{\circ}\text{C}$ ; The measured value is within specification with margin.  
For FANLESS system application, it is strongly recommended to add thermal dissipation design for better reliability.
- **Pass** :  $T_m < T_c - 10^{\circ}\text{C}$ ; The measured value is with safety margin.